

Semiconductor Ptfе Wafer Carrier 8 Inch Wet Cleaning Hf Resistant Etching Cassette

Item Number: PL-CP82



Introduction

Optimize semiconductor processing with this premium PTFE 8 inch wafer carrier designed for high-purity wet cleaning and HF etching applications. Our industrial-grade fluoropolymer cassettes ensure maximum chemical resistance, superior durability, and precise handling for sensitive cleanroom production environments.

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Application	Description	Key Benefit
Silicon Wafer Etching	Handling wafers during the removal of sacrificial layers using HF-based chemistries.	Complete resistance to acid attack ensures carrier longevity.
RCA Cleaning Process	Supporting wafers through multiple stages of organic and ionic contaminant removal.	Material purity prevents re-contamination of cleaned surfaces.
CMP Post-Cleaning	Transporting wafers through cleaning brushes and chemical baths after planarization.	Low particle shedding maintains extremely low defect counts.
Photoresist Stripping	Utilizing aggressive solvents to remove light-sensitive coatings after lithography.	Chemical inertness prevents material degradation in solvent baths.
Solar Cell Fabrication	Supporting large-scale substrate processing in high-acid environments for PV cells.	Durability in high-volume production reduces replacement costs.
MEMS Manufacturing	Managing delicate micro-electromechanical systems during complex wet release steps.	Precise slot alignment prevents mechanical damage to structures.
Analytical Sampling	Using the carrier as a substrate holder for high-purity trace metal analysis.	Ultra-low background levels ensure accurate laboratory results.

Feature Category	Technical Details for PL-CP82
Product Identification	PL-CP82 Series Custom Wafer Carrier
Primary Material	High-Purity Virgin PTFE (Polytetrafluoroethylene)
Wafer Size Compatibility	Standard 8-inch (200mm) / Fully Customizable diameters
Configuration Type	Single-wafer (individual) or Multi-slot available
Fabrication Method	100% Precision CNC Machining (No molding residues)
Temperature Range	-200°C to +260°C (-328°F to +500°F)
Chemical Compatibility	Universal (HF, HCl, H2SO4, KOH, Acetone, etc.)
Surface Roughness	Customizable based on specific cleanroom requirements
Slot Pitch / Depth	Tailored to client-specific process parameters
Handle/Interface	Custom robotic pick-up points or manual grip options

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Dimensional Accuracy	High-precision tolerance control per industrial standards	